

SC11202, SC11203 and SC11204 DTMF Receivers

FEATURES

- Built-in dial tone rejection
- Single 5-volt supply
- Three-state outputs
- Narrow 14 or 18 pin package

BENEFITS

- No external filters required
- Minimum system overhead
- Simple bus interface
- Minimum board space

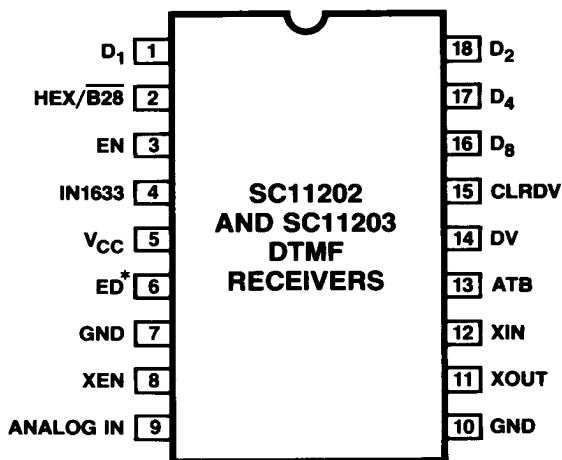
GENERAL DESCRIPTION

The SC11202, SC11203 and SC11204 are central office quality dual-tone, multi-frequency (DTMF) – touch tone – receivers built with Sierra's proprietary 3-micron CMOS process. They receive analog DTMF signals and decode them into the 16 standard digits. The SC11202 and SC11203 provide either a 4-bit hexadecimal code or binary coded 2 of 8, while the SC11204 provides 4-bit hex code only. The outputs are three state, CMOS logic compatible, facilitating bus interfaces. A built-in dial-tone rejection circuit eliminates the need for any front-end or prefiltering. The only external components required are an inexpensive 3.58 MHz crystal and a bias resistor for the time base. Up to ten DTMF receivers may be operated from a single crystal through the Alternate Time Base (ATB) pin.

The SC11202 is pin and function compatible to Silicon Systems' 202 (18-pin), the SC11203 is pin and function compatible with Silicon Systems' 203 (18-pin with an Early Detect output) and the SC11204 is a 14-pin device compatible with SSI's 204.

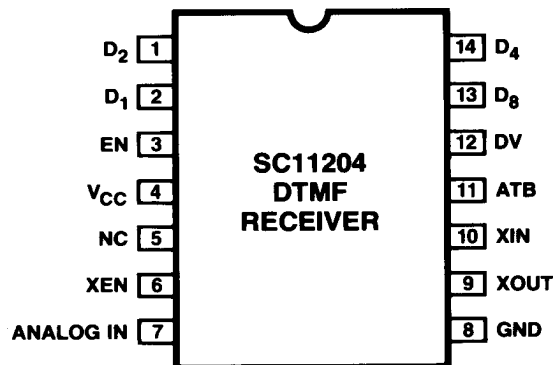
Applications include central office switches, PBXs, auto dialers for redialing a number over an alternate carrier, subscriber equipment such as telephone answering machines, remote banking or other transaction systems that employ DTMF signals for remote operation and voice/DTMF response systems.

CONNECTION DIAGRAMS



*SC11203 only
NC on SC11202

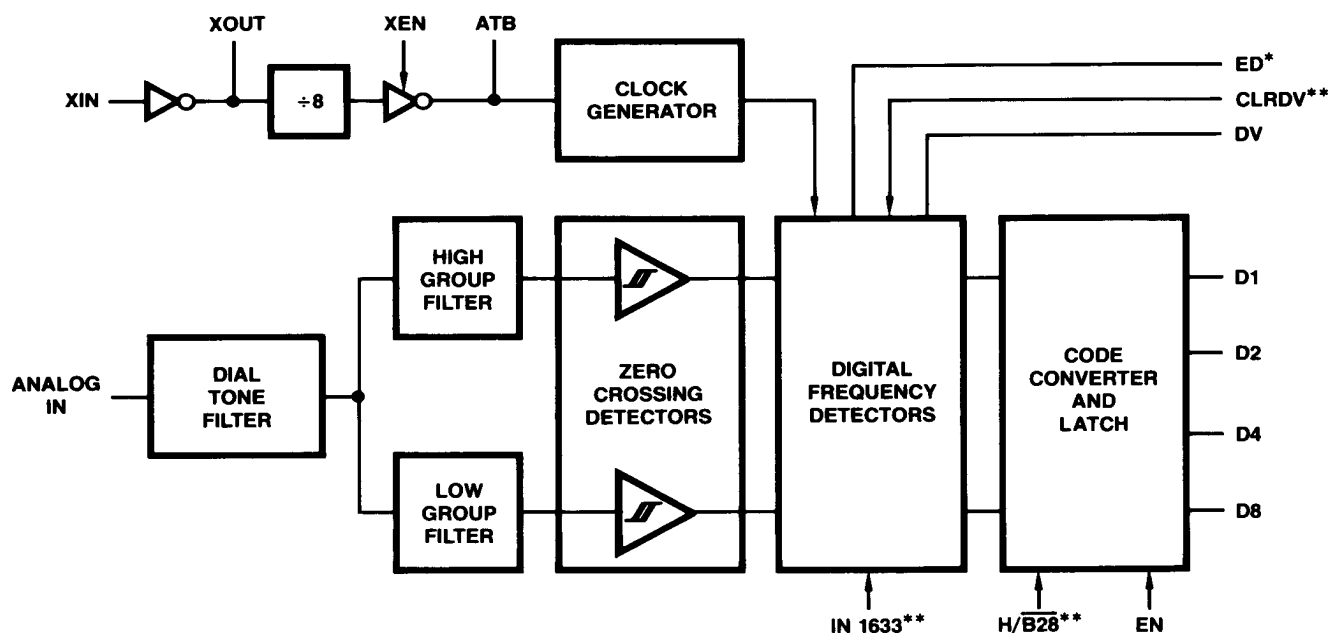
Order Number: SC11202CN
or SC11203CN



Order Number: SC11204CN

SC11202, SC11203 and SC11204 DTMF Receivers

BLOCK DIAGRAM



*SC11203 only

**SC11202 and SC11203

SC11202, SC11203 AND SC11204 DTMF RECEIVERS

DESCRIPTION OF PIN FUNCTIONS

Pin Number	Pin Name	Function	Pin Number	Pin Name	Function
1, 18, 17, 16	D1, D2 D4, D8	Digital outputs that provide the code corresponding to the detected digit. These outputs are push-pull CMOS when EN (pin 3) is high and are a high impedance, open circuit, when EN is low. In the SC11202 and SC11203, the digital output format is programmed by the HEX/B28 pin (2) to be either hexadecimal or binary coded 2 of 8 (see Table 3). In the SC11204, the output is hexadecimal and is on pins 2, 1, 14 and 13. These outputs become valid after a tone pair has been detected and they are cleared when a valid pause is timed.	4	IN1633	When tied high, this pin inhibits the detection of tone pairs containing the 1633 Hz component. To detect all 16 standard digits, IN1633 must be tied low. It has an internal pull-down to ground.
2	HEX/B28	Selects the digital output format on the SC11202 and SC11203. When HEX/B28 is high, the outputs on D1, D2, D4 and D8 are hexadecimal; when it is low, the outputs are binary coded 2 of 8. See table 3 for the hexadecimal and binary 2 of 8 codes.	5	VCC	Positive supply; 5 volts.
3	EN	Enables the digital outputs D1, D2, D4 and D8.	6	ED	Provided only on the SC11203, the ED output goes high as soon as a DTMF tone pair begins to be detected, and goes low when a pause begins to be detected. D1, D2, D4 and D8 outputs are guaranteed to be valid when DV is high, but are not necessarily valid when ED is high.
			7, 10	GND	Ground; 0 volts. Pin 10 must be tied to ground; pin 7 is optional.
			8	XEN	Enables the crystal oscillator. When high, the crystal oscillator is enabled. This pin should be tied low if the device is driven by an external oscillator through the ATB input.
			9	Analog IN	Accepts the analog input. This pin is internally biased so that the input signal may be AC



DESCRIPTION OF PIN FUNCTIONS

Pin Number	Pin Name	Function
11, 12	XOUT, XIN	coupled through a $0.01\mu\text{F}$ capacitor. The input may be DC coupled as long as it does not exceed the positive supply. Crystal oscillator output and input. A 3.58 MHz crystal in parallel with a 1 megohm, 10% resistor is connected between these pins. The oscillator is enabled by tying XEN (pin 8) high. In this mode, the clock frequency is also provided at the ATB output (pin 13).
13	ATB	Alternate time-base. For a device with a crystal and a resistor connected between pins 11 and 12, and XEN tied high, ATB is a

Pin Number	Pin Name	Function
14, 15	DV, CLRDV	447.5 kHz clock output that can be used to drive up to ten other DTMF receivers. For these devices, XEN must be tied low and ATB is an input. Data valid and clear data valid. DV goes high after a valid tone pair is sensed and decoded at the output of pins D1, D2, D4 and D8. DV remains high until a valid pause occurs or until the CLRDV input is taken high, whichever occurs first.
NC		NC indicates that no internal connection is made to the pin and it may be left floating.

TABLE 1. DTMF DIALING MATRIX

	Col 0	Col 1	Col 2	Col 3
Row 0	1	2	3	A
Row 1	4	5	6	B
Row 2	7	8	9	C
Row 3	*	0	#	D

TABLE 2. DETECTION FREQUENCY

Low Group f_0	High Group f_0
Row 0 = 697 Hz	Column 0 = 1209 Hz
Row 1 = 770 Hz	Column 1 = 1336 Hz
Row 2 = 852 Hz	Column 2 = 1477 Hz
Row 3 = 941 Hz	Column 3 = 1633 Hz

TABLE 3. HEX/ $\overline{\text{B28}}$ OUTPUT CODES

Digit	Hexadecimal				Binary Coded 2 of 8			
	D8	D4	D2	D1	D8	D4	D2	D1
1	0	0	0	1	0	0	0	0
2	0	0	1	0	0	0	0	1
3	0	0	1	1	0	0	1	0
4	0	1	0	0	0	1	0	0
5	0	1	0	1	0	1	0	1
6	0	1	1	0	0	1	1	0
7	0	1	1	1	1	0	0	0
8	1	0	0	0	1	0	0	1
9	1	0	0	1	1	0	1	0
0	1	0	1	0	1	1	0	1
*	1	0	1	1	1	1	0	0
#	1	1	0	0	1	1	1	0
A	1	1	0	1	0	0	1	1
B	1	1	1	0	0	1	1	1
C	1	1	1	1	1	0	1	1
D	0	0	0	0	1	1	1	1

**ABSOLUTE MAXIMUM RATINGS (Notes 1 and 2)**

Supply Voltage, V_{CC}	7V
DC Input Voltage	-0.5 to $V_{CC} + 0.5V$
Analog Input Voltage	$V_{CC} - 10V$ to $V_{CC} + 0.5V$
Storage Temperature Range	$-65^{\circ}C$ to $150^{\circ}C$
Power Dissipation (Note 3)	500mW
Lead Temperature (soldering, 10 sec.)	$300^{\circ}C$

OPERATING CONDITIONS

Parameter	Description	Conditions	Min	Typ	Max	Units
T_A	Ambient Temperature		0		70	$^{\circ}C$
V_{CC}	Positive Supply Voltage		4.5		5.5	V
GND	Ground			0		V
F_C	Crystal Frequency		3.576	3.579545	3.583	MHz

ELECTRICAL CHARACTERISTICS (Note 4)

Parameter	Conditions	Min	Typ	Max	Units
Frequency Detect Bandwidth		$\pm(1.5 + 2Hz)$	± 2.3	± 3.5	% of f_0
Amplitude for Detection	Each Tone SC11202 & SC11203	-32		-2	dBm Referenced to 600 Ω
Amplitude for Detection	Each Tone SC11204	-18		-2	dBm Referenced to 600 Ω
Minimum Acceptable Twist	Twist = $\frac{\text{High Tone}}{\text{Low Tone}}$	-10		+10	dB
60 Hz Tolerance				0.8	Vrms
Dial Tone Tolerance	"Precise" Dial Tone			0dB	dB Referenced to Lower Amplitude Tone
Talk Off	MITEL Tape #CM 7291		2		Hits
Digital Outputs (except XOUT)	"0" Level, 400 μA Load	0		0.5	Volts
	"1" Level, 200 μA Load	$V_{CC} - 0.5$		V_{CC}	Volts
Digital Inputs	"0" Level	0		0.3 V_{CC}	Volts
	"1" Level	0.7 V_{CC}		V_{CC}	Volts
Power Supply Noise	Wide Band			10	mV p-p
Supply Current	$T_A = 25^{\circ}C$		10	16	mA
Noise Tolerance	MITEL Tape #CM 7291			-12	dB Referenced to Lowest Amplitude Tone
Input Impedance	$V_{CC} \geq V_{IN} \geq V_{CC} - 10$	100k Ω /15pF			

Notes: 1. Absolute maximum ratings are those values beyond which damage to the device may occur.

2. Unless otherwise specified, all voltages are referenced to ground.

3. Power dissipation temperature derating -

Plastic package: -12mW/C from $65^{\circ}C$ to $85^{\circ}C$

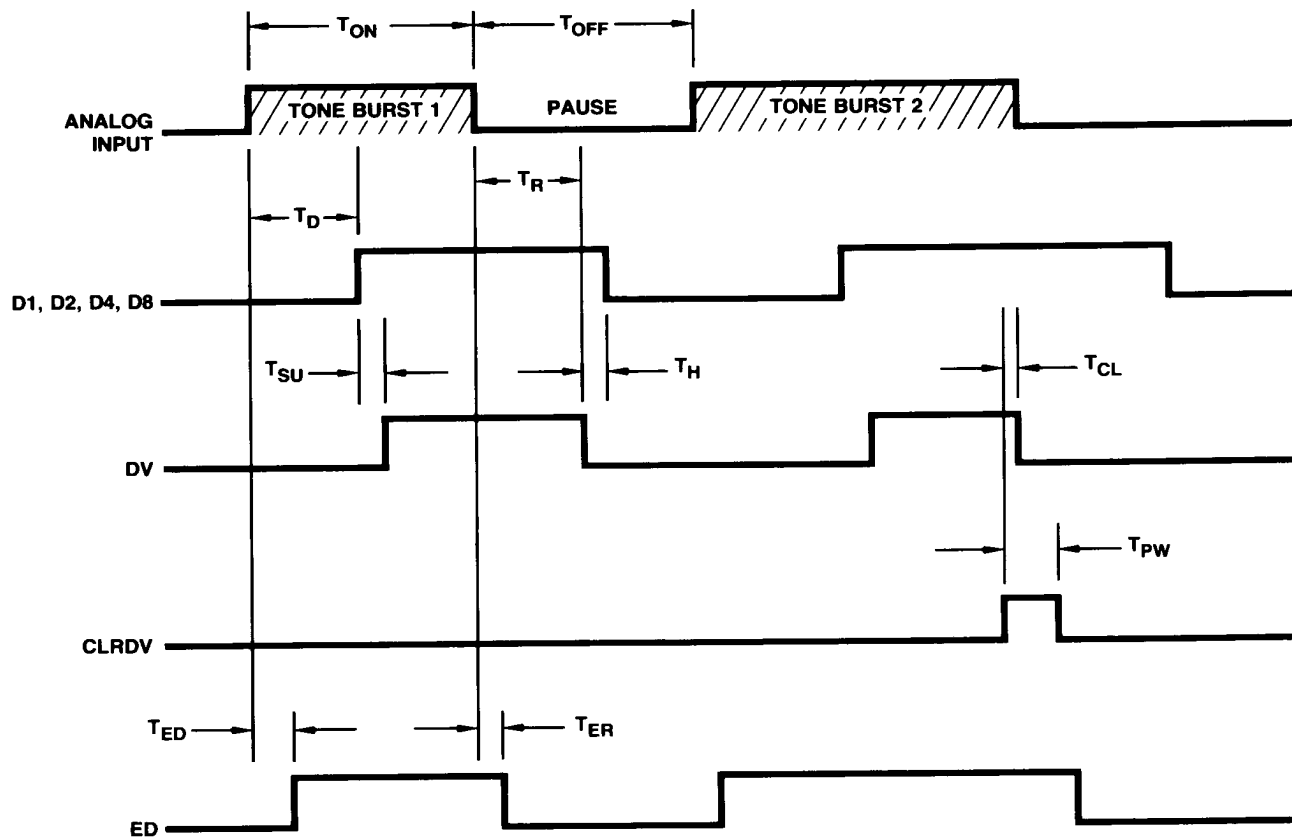
Ceramic package: -12mW/C from $100^{\circ}C$ to $125^{\circ}C$

4. Min and max values are valid over the full temperature and operating voltage range. Typical values are for $25^{\circ}C$ and 5 volt operation.



TIMING CHARACTERISTICS (at 25°C and 5V supply)

Parameter	Description	Conditions	Min	Typ	Max	Units
T_{ON}	Tone Time for Detection		40			ms
T_{ON}	Tone Time for Rejection				20	ms
T_{OFF}	Pause Time for Detection		40			ms
T_{OFF}	Pause Time for Rejection				20	ms
T_D	Detect Time		25		46	ms
T_R	Release Time		35		50	ms
T_{SU}	Data Setup Time		7			μ s
T_H	Data Hold Time		4.2		5.0	ms
T_{CL}	DV Clear Time			160	250	ns
T_{PW}	CLR DV Pulse Width		200			ns
T_{ED}	ED Detect Time		7		22	ms
T_{ER}	ED Release Time		2		18	ms
T_{OE}	Output Enable Time	$C_L = 50\text{pF}$ $R_L = 1\text{k}\Omega$		200	300	ns
T_{OD}	Output Disable Time	$C_L = 35\text{pF}$ $R_L = 500\Omega$		150	200	ns
T_{OR}	Output Rise Time	$C_L = 50\text{pF}$		200	300	ns
T_{OF}	Output Fall Time	$C_L = 50\text{pF}$		160	250	ns



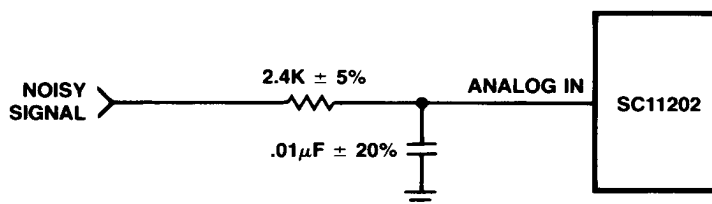
DTMF RECEIVER TIMING



APPLICATION NOTES

The DTMF receiver will tolerate total input rms noise up to 12dB below the lowest amplitude tone. For most telephone applications, the combination of the high frequency attenuation of the telephone line and internal band-limiting make special circuitry at the input to the DTMF receiver unnecessary. However, noise near the 74.6 kHz internal sampling frequency will be aliased (folded back) into the audio spectrum; if excessive noise

is present above 37.3 kHz, the simple RC filter shown below can be employed to band limit the incoming signal. Noise will also be reduced by placing a ground trace around the XIN and XOUT pins on the circuit board layout when using a crystal. XOUT is not intended to drive an additional device. XIN may be driven externally in which case XOUT must be left floating.

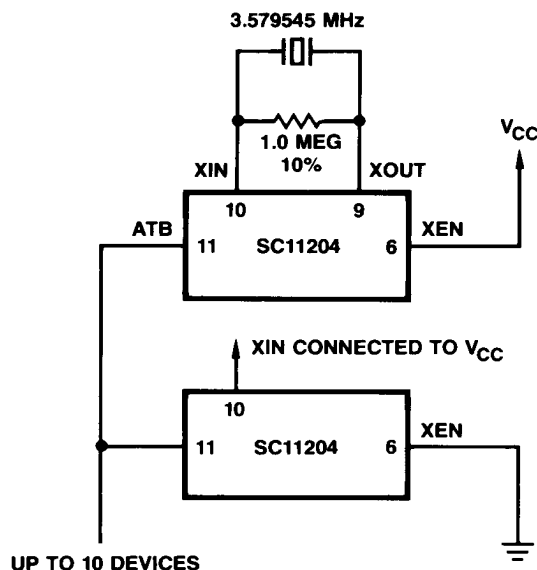


For use in extreme high frequency input noise environment.

CRYSTAL OSCILLATOR

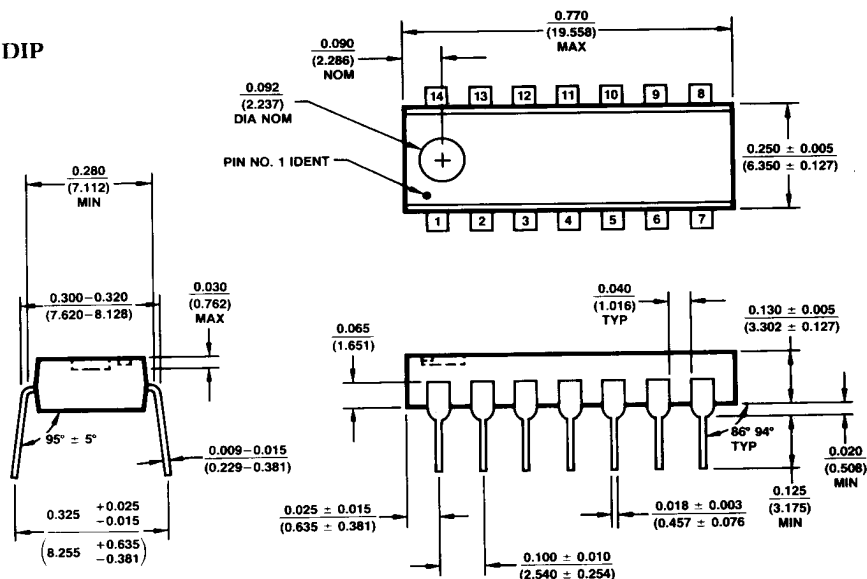
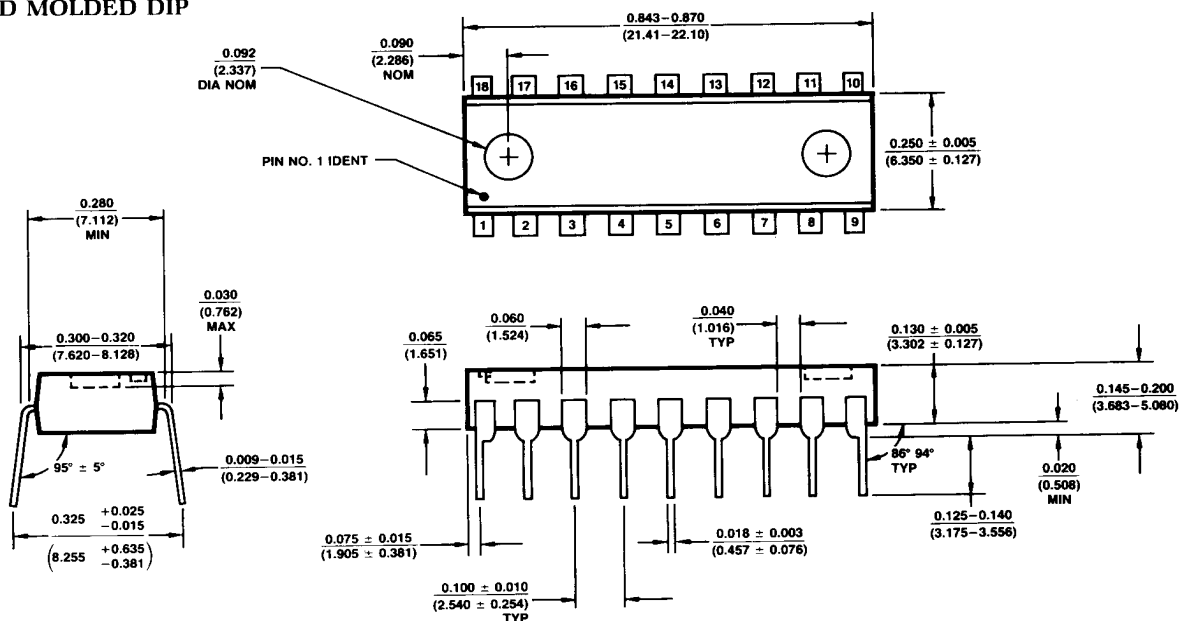
The DTMF receivers contain an onboard inverter with sufficient gain to provide oscillation when connected to a low-cost television color-burst crystal. The crystal oscillator is enabled by tying XEN high. The crystal is connected between XIN and XOUT. A 1 megohm 10% resistor is also connected between these pins. In this

mode, ATB is a clock frequency output. Other DTMF receivers may use the same frequency reference by tying their ATB pins to the ATB of a crystal connected device. XIN and XEN of the auxiliary devices must then be tied high and low respectively. Ten devices may run off a single DTMF receiver with a crystal as shown below.





PHYSICAL DIMENSIONS — Inches (Millimeters)

PACKAGE N14A (N)
14-LEAD MOLDED DIPPACKAGE N18A (N)
18-LEAD MOLDED DIP

Devices sold by Sierra Semiconductor Corp. are covered by the warranty and patent indemnification provisions appearing in its Terms of Sale only. Sierra Semiconductor Corp. makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. Sierra Semiconductor Corp. makes no warranty of merchantability or fitness for any purpose. Sierra Semiconductor Corp. reserves the right to discontinue production and change specifications and prices at any time and without notice.

This product is intended for use in normal commercial applications. Applications requiring an extended temperature range, unusual environmental requirements, or high reliability applications, such as military and aerospace, are specifically not recommended without additional processing by Sierra Semiconductor Corp.

Sierra Semiconductor assumes no responsibility for the use of any circuitry other than circuitry embodied in a Sierra Semiconductor Corp. product. No other circuits, patents, licenses are implied.

Life Support Policy

Sierra Semiconductor Corporation's products are not authorized for use as critical components in life support devices or systems.

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.